## **Board Stack Report**

Stack Up		Layer Stack			
Layer	<b>Board Layer Stack</b>	Name	Material	Thickness	Constant
1		Top Paste			
2		Top Overlay			
3		Top Solder	Solder Resist	0,015mm	3,5
4		Top Copper	Copper	0,035mm	
5		Dielectric 1	FR-4	0,360mm	4,6
6		Supply	Copper	0,035mm	
7		Dielectric 2	FR-4	0,700mm	4,6
8		GND	Copper	0,035mm	
9		Dielectric 3	FR-4	0,360mm	4,6
10		Bot Copper	Copper	0,035mm	
11		Bottom Solder	Solder Resist	0,015mm	3,5
12		<b>Bottom Overlay</b>			
13		Bottom Paste			
	Height : 1,590mm				